

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kyoung-Ju Shin, et al.  
Assignee: Samsung Electronics Co., Ltd.  
Title: THIN FILM DIODE PANEL AND MANUFACTURING METHOD  
OF THE SAME  
Serial No.: 10/578,028  
Confirmation No.: 9578  
Examiner: Thanh Nhan P. Nguyen      Group Art Unit: 2871  
Docket No.: PANK01883 US

October 19, 2010

Attn: Office of Initial Patent Examination  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**Request to Correct Filing Receipt**

Applicant respectfully requests a new filing receipt with the following correction to the Filing Receipt, dated November 13, 2006.

- In the Section "Applicants" the name of the fifth inventor is incorrect. It should read: **Sung-Jin Hong**.

A copy of the Filing Receipt dated November 13, 2006 is attached showing the correction. Also attached is a copy of the originally filed declaration, showing the name of the fifth named inventor.

CERTIFICATE OF EFS-WEB TRANSMISSION  
Certificate of Transmission: I hereby certify that this correspondence is being transmitted to the United States Patent and Trademark Office (USPTO) via the USPTO's EFS-Web electronic filing system on October 19, 2010.

Typed or printed name of person signing this certificate:

Gideon Gimlan

Signature: /gideon gimlan/

Respectfully submitted,

/gideon gimlan/  
Gideon Gimlan  
Attorney for Applicants  
Reg. No. 31,955  
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## UNITED STATES PATENT AND TRADEMARK OFFICE

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| APPLICATION NUMBER | FILING or 371(c)<br>DATE | GRP ART UNIT | FIL FEE REC'D | ATTY DOCKET NO | DRAWINGS | TOT CLAIMS | IND CLAIMS |
|--------------------|--------------------------|--------------|---------------|----------------|----------|------------|------------|
| 10/578,028         | 04/27/2006               | 2871         | 900           | AB-1883 US     | 13       | 14         | 2          |

CONFIRMATION NO. 9578

## FILING RECEIPT

32605  
MACPHERSON KWOK CHEN & HEID LLP  
2033 GATEWAY PLACE  
SUITE 400  
SAN JOSE, CA 95110

Date Mailed: 11/13/2006

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. **If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).**

## Applicant(s)

Kyoung-Ju Shin, Gyeonggi-do, KOREA,  
REPUBLIC OF;  
Chong-Chul Chai, Seoul, KOREA, REPUBLIC OF;  
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**Power of Attorney:** The patent practitioners associated with Customer Number 32605

## Domestic Priority data as claimed by applicant

This application is a 371 of PCT/KR04/02742 10/28/2004

## Foreign Applications

REPUBLIC OF KOREA 10-2003-0075870 10/29/2003

**If Required, Foreign Filing License Granted:** 11/11/2006

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is **US10/578,028**

**Projected Publication Date:** 02/22/2007

**Non-Publication Request:** No

**Early Publication Request:** No

**Title**

Thin film diode panel and manufacturing method of the same

**Preliminary Class**

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Since the rights granted by a U.S. patent extend only throughout the territory of the United States and have no effect in a foreign country, an inventor who wishes patent protection in another country must apply for a patent in a specific country or in regional patent offices. Applicants may wish to consider the filing of an international application under the Patent Cooperation Treaty (PCT). An international (PCT) application generally has the same effect as a regular national patent application in each PCT-member country. The PCT process **simplifies** the filing of patent applications on the same invention in member countries, but **does not result** in a grant of "an international patent" and does not eliminate the need of applicants to file additional documents and fees in countries where patent protection is desired.

Almost every country has its own patent law, and a person desiring a patent in a particular country must make an application for patent in that country in accordance with its particular laws. Since the laws of many countries differ in various respects from the patent law of the United States, applicants are advised to seek guidance from specific foreign countries to ensure that patent rights are not lost prematurely.

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**Title 37, Code of Federal Regulations, 5.11 & 5.15**

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# DECLARATION FOR PATENT APPLICATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below adjacent to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of subject matter (process, machine, manufacture, or composition of matter, or an improvement thereof) which is claimed and for which a patent is sought by way of the application entitled

## THIN FILM DIODE PANEL AND MANUFACTURING METHOD OF THE SAME

which (check) ☐ is attached hereto.  
☐ is amended by the Preliminary Amendment attached hereto.  
☒ was filed on October 28, 2004  
as Application Serial No. PCT/KR2004/002742  
☐ was amended on (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information, which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) of any foreign application(s) for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America listed below and have also identified below any foreign application(s) for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America filed by me on the same subject matter having a filing date before that of the application(s) of which priority is claimed:

| Prior Foreign Application(s) |         |                      | Priority Claimed                    |                          |
|------------------------------|---------|----------------------|-------------------------------------|--------------------------|
| Number                       | Country | Day/Month/Year Filed | Yes                                 | No                       |
| 10-2003-0075870              | KR      | 29/10/2003           | <input checked="" type="checkbox"/> | <input type="checkbox"/> |
|                              |         |                      | <input type="checkbox"/>            | <input type="checkbox"/> |
|                              |         |                      | <input type="checkbox"/>            | <input type="checkbox"/> |

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below:

| Provisional Application Number | Filing Date |
|--------------------------------|-------------|
|                                |             |

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) or PCT international application(s) designating the United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior application(s) in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information, which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56, which became available between the filing date of the prior application(s) and the national or PCT international filing date of this application:

| Application Serial No. | Filing Date | Status (patented, pending, abandoned) |
|------------------------|-------------|---------------------------------------|
| PCT/KR2004/002742      | 2004-10-28  |                                       |

I hereby appoint the following practitioners to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith:

Customer No. 32605

Please address all correspondence and telephone calls to:

David W. Heid  
**MacPHERSON KWOK CHEN & HEID LLP**  
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 Telephone: 408-392-9250  
 Facsimile: 408-392-9262

I declare that all statements made herein of my own knowledge are true, all statements made herein on information and belief are believed to be true, and all statements made herein are made with the knowledge that whoever, in any matter within the jurisdiction of the Patent and Trademark Office, knowingly and willfully falsifies, conceals, or covers up by any trick, scheme, or device a material fact, or makes any false, fictitious or fraudulent statements or representations, or makes or uses any false writing or document knowing the same to contain any false, fictitious or fraudulent statement or entry, shall be subject to the penalties including fine or imprisonment or both as set forth under 18 U.S.C. 1001, and that violations of this paragraph may jeopardize the validity of the application or this document, or the validity or enforceability of any patent, trademark registration, or certificate resulting therefrom.

|                                      |   |               |       |
|--------------------------------------|---|---------------|-------|
| Full name of sole or first inventor: | SHIN, Kyoung-Ju   |               |       |
| Inventor's Signature:                | <i>Shin, Kyoung-Ju</i>  | Date:         |       |
| Residence:                           | Samjeong Seonbi Maeul 162-504, 289-12, Bora-ri, Gjeheung-eup, Yongin-si, Gyeonggi-do 449-900, Korea | March 7, 2006 |       |
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|                                      |   |               |       |

|                               |   |                  |       |
|-------------------------------|---|------------------|-------|
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| Inventor's Signature:         | <i>Hong, Sung-Jin</i>   | Date:            |       |
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